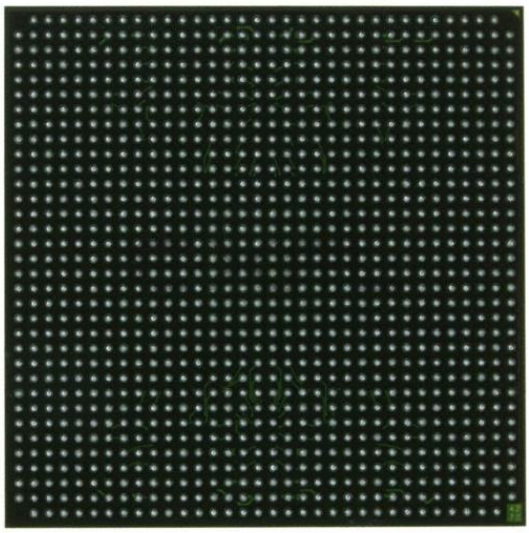
AMD Xilinx - XC2VP50-7FFG1152C Datasheet



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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	5904
Number of Logic Elements/Cells	53136
Total RAM Bits	4276224
Number of I/O	692
Number of Gates	-
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1152-BBGA, FCBGA
Supplier Device Package	1152-FCBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2vp50-7ffg1152c

Table 11: **LVCMOS Programmable Currents (Sink and Source)**

SelectIO-Ultra	Programmable Current (Worst-Case Guaranteed Minimum)						
LVTTL	2 mA	4 mA	6 mA	8 mA	12 mA	16 mA	24 mA
LVCMOS33	2 mA	4 mA	6 mA	8 mA	12 mA	16 mA	24 mA
LVCMOS25	2 mA	4 mA	6 mA	8 mA	12 mA	16 mA	24 mA
LVCMOS18	2 mA	4 mA	6 mA	8 mA	12 mA	16 mA	n/a
LVCMOS15	2 mA	4 mA	6 mA	8 mA	12 mA	16 mA	n/a

Figure 23 shows the SSTL2, SSTL18, and HSTL configurations. HSTL can sink current up to 48 mA. (HSTL IV)

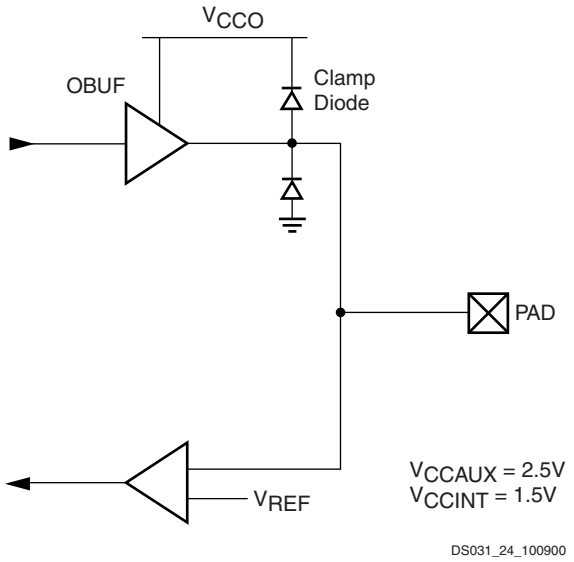

Figure 23: **SSTL or HSTL SelectIO-Ultra Standards**

All pads are protected against damage from electrostatic discharge (ESD) and from over-voltage transients. Virtex-II Pro uses two memory cells to control the configuration of an I/O as an input. This is to reduce the probability of an I/O configured as an input from flipping to an output when subjected to a single event upset (SEU) in space applications.

Prior to configuration, all outputs not involved in configuration are forced into their high-impedance state. The pull-down resistors and the weak-keeper circuits are inactive. The dedicated pin HSWAP_EN controls the pull-up resistors prior to configuration. By default, HSWAP_EN is set High, which disables the pull-up resistors on user I/O pins. When HSWAP_EN is set Low, the pull-up resistors are activated on user I/O pins.

All Virtex-II Pro IOBs (except RocketIO transceiver pins) support IEEE 1149.1 and IEEE 1532 compatible Boundary-Scan testing.

Input Path

The Virtex-II Pro IOB input path routes input signals directly to internal logic and / or through an optional input flip-flop or latch, or through the DDR input registers. An optional delay element at the D-input of the storage element eliminates pad-to-pad hold time. The delay is matched to the internal clock-distribution delay of the Virtex-II Pro device, and when used, assures that the pad-to-pad hold time is zero.

Each input buffer can be configured to conform to any of the low-voltage signaling standards supported. In some of these standards the input buffer utilizes a user-supplied threshold voltage, V_{REF}. The need to supply V_{REF} imposes constraints on which standards can be used in the same bank. See I/O banking description.

Output Path

The output path includes a 3-state output buffer that drives the output signal onto the pad. The output and / or the 3-state signal can be routed to the buffer directly from the internal logic or through an output / 3-state flip-flop or latch, or through the DDR output / 3-state registers.

Each output driver can be individually programmed for a wide range of low-voltage signaling standards. In most signaling standards, the output High voltage depends on an externally supplied V_{CCO} voltage. The need to supply V_{CCO} imposes constraints on which standards can be used in the same bank. See I/O banking description.

I/O Banking

Some of the I/O standards described above require V_{CCO} and V_{REF} voltages. These voltages are externally supplied and connected to device pins that serve groups of IOB blocks, called banks. Consequently, restrictions exist about which I/O standards can be combined within a given bank.

Eight I/O banks result from dividing each edge of the FPGA into two banks, as shown in Figure 24 and Figure 25. Each bank has multiple V_{CCO} pins, all of which must be connected to the same voltage. This voltage is determined by the output standards in use.

synchronously. The sequence can also be paused at any stage, until lock has been achieved on any or all DCMs, as well as DCI.

Readback

In this mode, configuration data from the Virtex-II Pro FPGA device can be read back. Readback is supported only in the SelectMAP (master and slave) and Boundary-Scan mode.

Along with the configuration data, it is possible to read back the contents of all registers, distributed SelectRAM+, and block RAM resources. This capability is used for real-time debugging. For more detailed configuration information, see the *Virtex-II Pro Platform FPGA User Guide.*

Bitstream Encryption

Virtex-II Pro devices have an on-chip decryptor using one or two sets of three keys for triple-key Data Encryption Standard (DES) operation. Xilinx software tools offer an optional encryption of the configuration data (bitstream) with a triple-key DES determined by the designer.

The keys are stored in the FPGA by JTAG instruction and retained by a battery connected to the V_{BATT} pin, when the device is not powered. Virtex-II Pro devices can be configured with the corresponding encrypted bitstream, using any of the configuration modes described previously.

A detailed description of how to use bitstream encryption is provided in the ***Virtex-II Pro Platform FPGA User Guide***. Your local FAE can also provide specific information on this feature.

Partial Reconfiguration

Partial reconfiguration of Virtex-II Pro devices can be accomplished in either Slave SelectMAP mode or Boundary-Scan mode. Instead of resetting the chip and doing a full configuration, new data is loaded into a specified area of the chip, while the rest of the chip remains in operation. Data is loaded on a column basis, with the smallest load unit being a configuration “frame” of the bitstream (device size dependent).

Partial reconfiguration is useful for applications that require different designs to be loaded into the same area of a chip, or that require the ability to change portions of a design without having to reset or reconfigure the entire chip.

For more information on Partial Reconfiguration in Virtex-II Pro devices, please refer to Xilinx Application Note **XAPP290**, *Two Flows for Partial Reconfiguration*.

Revision History

This section records the change history for this module of the data sheet.

Date	Version	Revision
01/31/02	1.0	Initial Xilinx release.
06/13/02	2.0	New Virtex-II Pro family members. New timing parameters per speedsfile **v1.62**.
09/03/02	2.1	• Revised Reset and Power sections. • Updated Table 8, which lists compatible input standards. [Table deleted in v2.6.] • Added Figure 28, Figure 29, and Figure 30, which provide examples illustrating the use of I/O standards.
09/27/02	2.2	• In section RocketIO Overview, corrected max number of MGTs from 16 to 24. • In section Input/Output Blocks (IOBs), added references to XAPP653 regarding implementation of 3.3V I/O standards.
11/20/02	2.3	• Table 8: Added rows for LVTTL, LVCMOS33, and PCI-X. • Table 8: Added LVTTL and LVCMOS33 to compatible 3.3V cells. [Table deleted in v2.6.] • Table 33: Correct bitstream lengths.
12/03/02	2.4	• Added mention of LVTTL and PCI with respect to SelectIO-Ultra configurations. See section Input/Output Individual Options and Figure 22.
01/20/03	2.5	• Added qualification to features vs. Virtex-II (open-drain output pin TDO does not have internal pull-up resistor) • Table 7: Added HSTL18 (I, II, III, & IV) and HSTL18_DCI (I,II, III & IV) to 1.8V VCCO row. [Table deleted in v2.6.] • Table 8: Numerous revisions. [Table deleted in v2.6.]

Table 32: **RocketIO RXUSRCLK2 Switching Characteristics *(Continued)***

		Speed Grade			
Description	**Symbol**	**-7**	**-6**	**-5**	**Units**
RXBUFSTATUS status outputs	$T_{GCKST_}$RBSTA	0.45	0.45	0.50	ns, max
RXCHECKINGCRC status output	$T_{GCKST_}$RCCRC	0.36	0.40	0.44	ns, max
RXCRCERR status output	$T_{GCKST_}$RCRCE	0.36	0.40	0.44	ns, max
CHBONDDONE status output	$T_{GCKST_}$CHBD	0.50	0.50	0.55	ns, max
RXCHARISK status outputs	$T_{GCKST_}$RKCH	0.50	0.50	0.55	ns, max
RXRUNDISP status outputs	$T_{GCKST_}$RRDIS	0.50	0.50	0.55	ns, max
RXDATA data outputs	$T_{GCKDO_}$RDAT	0.50	0.50	0.55	ns, max
Clock					
RXUSRCLK2 minimum pulse width, High	$T_{GPWH_}$RX2	1.42	1.42	2.25	ns, min
RXUSRCLK2 minimum pulse width, Low	$T_{GPWL_}$RX2	1.42	1.42	2.25	ns, min

Table 33: **RocketIO X TXUSRCLK2 Switching Characteristics**

		Speed Grade			
Description	**Symbol**	**-7**	**-6**	**-5**	**Units**
Setup and Hold Relative to Clock (TXUSRCLK2)					
TXBYPASS8B10B control inputs	$T_{GCCK_}$TBYP/$T_{GCKC_}$TBYP				ns, min
TXPOLARITY control input	$T_{GCCK_}$TPOL/$T_{GCKC_}$TPOL				ns, min
TXINHIBIT control inputs	$T_{GCCK_}$TINH/$T_{GCKC_}$TINH				ns, min
LOOPBACK control inputs	$T_{GCCK_}$LBK/$T_{GCKC_}$LBK				ns, min
TXRESET control input	$T_{GCCK_}$TRST/$T_{GCKC_}$TRST				ns, min
TXCHARISK control inputs	$T_{GCCK_}$TKCH/$T_{GCKC_}$TKCH				ns, min
TXCHARDISPMODE control inputs	$T_{GCCK_}$TCDM/$T_{GCKC_}$TCDM				ns, min
TXCHARDISPVAL control inputs	$T_{GCCK_}$TCDV/$T_{GCKC_}$TCDV				ns, min
TXDATAWIDTH control inputs	$T_{GCCK_}$TDATW/$T_{GCCK_}$TDATW				ns, min
TXENC64B66BUSE TXENC8B10BUSE control inputs	$T_{GCCK_}$TENC/$T_{GCCK_}$TENC				ns, min
TXINTDATAWIDTH control inputs	$T_{GCCK_}$TIDATW/$T_{GCCK_}$TIDATW				ns, min
TXGEARBOX64B66BUSE control inputs	$T_{GCCK_}$TXGEAR/$T_{GCCK_}$TXGEAR				ns, min
TXSCRAM64B66BUSE control inputs	$T_{GCCK_}$TXSCBL/$T_{GCCK_}$TXSCBL				ns, min
REFCLKSEL REFCLKBSEL control inputs	$T_{GCCK_}$RFCKSL/$T_{GCCK_}$RFCKSL				ns, min
TXDATA data inputs	$T_{GDCK_}$TDAT/$T_{GCKD_}$TDAT				ns, min
Clock to Out					
TXBUFERR status output	$T_{GCKST_}$TBERR				ns, max
TXKERR status outputs	$T_{GCKST_}$TKERR				ns, max
TXRUNDISP status outputs	$T_{GCKST_}$TRDIS				ns, max
Clock					
TXUSRCLK2 minimum pulse width, High	$T_{GPWH_}$TX2				ns, min
TXUSRCLK2 minimum pulse width, Low	$T_{GPWL_}$TX2				ns, min

Miscellaneous Timing Parameters

Table 61: **Miscellaneous Timing Parameters**

Description	Symbol	Constraints F_{CLKIN}	Speed Grade			Units
			-7	-6	-5	
Time Required to Achieve LOCK						
Using DLL outputs(1)	LOCK_DLL:					
	LOCK_DLL_60	> 60MHz	20.00	20.00	20.00	us
	LOCK_DLL_50_60	50 - 60 MHz	25.00	25.00	25.00	us
	LOCK_DLL_40_50	40 - 50 MHz	50.00	50.00	50.00	us
	LOCK_DLL_30_40	30 - 40 MHz	90.00	90.00	90.00	us
	LOCK_DLL_24_30	24 - 30 MHz	120.00	120.00	120.00	us
Using CLKFX outputs	LOCK_FX_MIN		10.00	10.00	10.00	ms
	LOCK_FX_MAX		10.00	10.00	10.00	ms
Additional lock time with fine phase shifting	LOCK_DLL_FINE_SHIFT		50.00	50.00	50.00	us
Fine Phase Shifting						
Absolute shifting range	FINE_SHIFT_RANGE		10.00	10.00	10.00	ns
Delay Lines						
Tap delay resolution	DCM_TAP_MIN		30.00	30.00	30.00	ps
	DCM_TAP_MAX		50.00	50.00	50.00	ps

Notes:
1. “DLL outputs” is used here to describe the outputs: CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV.

Frequency Synthesis

Table 62: **Frequency Synthesis**

Attribute	Min	Max
CLKFX_MULTIPLY	2	32
CLKFX_DIVIDE	1	32

Parameter Cross-Reference

Table 63: **Parameter Cross-Reference**

Libraries Guide	Data Sheet
DLL_CLKOUT_{MIN|MAX}_LF	CLKOUT_FREQ_{1X|2X|DV}_LF
DFS_CLKOUT_{MIN|MAX}_LF	CLKOUT_FREQ_FX_LF
DLL_CLKIN_{MIN|MAX}_LF	CLKIN_FREQ_DLL_LF
DFS_CLKIN_{MIN|MAX}_LF	CLKIN_FREQ_FX_LF
DLL_CLKOUT_{MIN|MAX}_HF	CLKOUT_FREQ_{1X|DV}_HF
DFS_CLKOUT_{MIN|MAX}_HF	CLKOUT_FREQ_FX_HF
DLL_CLKIN_{MIN|MAX}_HF	CLKIN_FREQ_DLL_HF
DFS_CLKIN_{MIN|MAX}_HF	CLKIN_FREQ_FX_HF

Table 7: **FG676/FGG676 — XC2VP20, XC2VP30, and XC2VP40**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP20	XC2VP30	XC2VP40
3	IO_L03P_3	AC25			
3	IO_L02N_3	AC24			
3	IO_L02P_3	AD25			
3	IO_L01N_3/VRP_3	AD26			
3	IO_L01P_3/VRN_3	AE26			
4	IO_L01N_4/BUSY/DOUT(1)	AB22			
4	IO_L01P_4/INIT_B	AC22			
4	IO_L02N_4/D0/DIN(1)	AB21			
4	IO_L02P_4/D1	AC21			
4	IO_L03N_4/D2	Y20			
4	IO_L03P_4/D3	AA20			
4	IO_L05_4/No_Pair	AB20			
4	IO_L06N_4/VRP_4	AC20			
4	IO_L06P_4/VRN_4	AD20			
4	IO_L07N_4	W19			
4	IO_L07P_4/VREF_4	Y19			
4	IO_L09N_4	AA19			
4	IO_L09P_4/VREF_4	AB19			
4	IO_L37N_4	AE19			
4	IO_L37P_4	AF19			
4	IO_L39N_4	W18			
4	IO_L39P_4	Y18			
4	IO_L43N_4	AA18			
4	IO_L43P_4	AB18			
4	IO_L45N_4	AC18			
4	IO_L45P_4/VREF_4	AD18			
4	IO_L46N_4	W17			
4	IO_L46P_4	W16			
4	IO_L48N_4	AB17			
4	IO_L48P_4	AB16			
4	IO_L49N_4	AC17			
4	IO_L49P_4	AD17			
4	IO_L50_4/No_Pair	Y16			
4	IO_L53_4/No_Pair	AA16			

Table 8: **FF672 — XC2VP2, XC2VP4, and XC2VP7**

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
6	IO_L01P_6/VRN_6	AF24			
6	IO_L01N_6/VRP_6	AE24			
6	IO_L02P_6	AD23			
6	IO_L02N_6	AC24			
6	IO_L03P_6	AE26			
6	IO_L03N_6/VREF_6	AF25			
6	IO_L04P_6	AD25			
6	IO_L04N_6	AD26			
6	IO_L05P_6	AC25			
6	IO_L05N_6	AC26			
6	IO_L06P_6	AB23			
6	IO_L06N_6	AB24			
6	IO_L39P_6	AB25	NC	NC	NC
6	IO_L39N_6/VREF_6	AB26	NC	NC	NC
6	IO_L41P_6	AA22	NC	NC	NC
6	IO_L41N_6	AA23	NC	NC	NC
6	IO_L42P_6	AA24	NC	NC	NC
6	IO_L42N_6	AA25	NC	NC	NC
6	IO_L43P_6	Y21	NC		
6	IO_L43N_6	Y22	NC		
6	IO_L44P_6	Y23	NC		
6	IO_L44N_6	Y24	NC		
6	IO_L45P_6	AA26	NC		
6	IO_L45N_6/VREF_6	Y26	NC		
6	IO_L46P_6	W21	NC		
6	IO_L46N_6	W22	NC		
6	IO_L47P_6	W23	NC		
6	IO_L47N_6	W24	NC		
6	IO_L48P_6	W25	NC		
6	IO_L48N_6	W26	NC		
6	IO_L49P_6	V20	NC		
6	IO_L49N_6	V21	NC		
6	IO_L50P_6	V22	NC		
6	IO_L50N_6	V23	NC		
6	IO_L51P_6	V24	NC		
6	IO_L51N_6/VREF_6	V25	NC		
6	IO_L52P_6	U21	NC		

Table 9: **FF896 — XC2VP7, XC2VP20, XC2VPX20, and XC2VP30**

Bank	Pin Description		Pin Number	No Connects		
	Virtex-II Pro devices	XC2VPX20 (if Different)		XC2VP7	XC2VP20, XC2VPX20	XC2VP30
0	IO_L01N_0/VRP_0		E25			
0	IO_L01P_0/VRN_0		E24			
0	IO_L02N_0		F24			
0	IO_L02P_0		F23			
0	IO_L03N_0		E23			
0	IO_L03P_0/VREF_0		E22			
0	IO_L05_0/No_Pair		G23			
0	IO_L06N_0		H22			
0	IO_L06P_0		G22			
0	IO_L07N_0		F22			
0	IO_L07P_0		F21			
0	IO_L08N_0		D24			
0	IO_L08P_0		C24			
0	IO_L09N_0		H21			
0	IO_L09P_0/VREF_0		G21			
0	IO_L37N_0		E21			
0	IO_L37P_0		D21			
0	IO_L38N_0		D23			
0	IO_L38P_0		C23			
0	IO_L39N_0		H20			
0	IO_L39P_0		G20			
0	IO_L43N_0		E20			
0	IO_L43P_0		D20			
0	IO_L44N_0		B23			
0	IO_L44P_0		A23			
0	IO_L45N_0		H19			
0	IO_L45P_0/VREF_0		G19			
0	IO_L46N_0		E19	NC		
0	IO_L46P_0		E18	NC		
0	IO_L47N_0		C22	NC		
0	IO_L47P_0		B22	NC		
0	IO_L48N_0		F20	NC		
0	IO_L48P_0		F19	NC		
0	IO_L49N_0		G17	NC		
0	IO_L49P_0		F17	NC		
0	IO_L50_0/No_Pair		B21	NC		

Table 9: **FF896 — XC2VP7, XC2VP20, XC2VPX20, and XC2VP30**

Bank	Pin Description		Pin Number	No Connects		
	Virtex-II Pro devices	XC2VPX20 (if Different)		XC2VP7	XC2VP20, XC2VPX20	XC2VP30
7	IO_L54N_7		L26			
7	IO_L53P_7		N26			
7	IO_L53N_7		N25			
7	IO_L52P_7		M30			
7	IO_L52N_7/VREF_7		L30			
7	IO_L51P_7		K28			
7	IO_L51N_7		K27			
7	IO_L50P_7		N24			
7	IO_L50N_7		N23			
7	IO_L49P_7		L29			
7	IO_L49N_7		K29			
7	IO_L48P_7		J28			
7	IO_L48N_7		J27			
7	IO_L47P_7		M26			
7	IO_L47N_7		M25			
7	IO_L46P_7		K30			
7	IO_L46N_7/VREF_7		J30			
7	IO_L45P_7		K26			
7	IO_L45N_7		K25			
7	IO_L44P_7		M24			
7	IO_L44N_7		M23			
7	IO_L43P_7		J29			
7	IO_L43N_7		H29			
7	IO_L42P_7		H28	NC		
7	IO_L42N_7		H27	NC		
7	IO_L41P_7		L24	NC		
7	IO_L41N_7		L23	NC		
7	IO_L40P_7		G30	NC		
7	IO_L40N_7/VREF_7		G29	NC		
7	IO_L39P_7		G28	NC		
7	IO_L39N_7		G27	NC		
7	IO_L38P_7		J26	NC		
7	IO_L38N_7		J25	NC		
7	IO_L37P_7		F30	NC		
7	IO_L37N_7		F29	NC		
7	IO_L36P_7		F28	NC		

Table 9: **FF896 — XC2VP7, XC2VP20, XC2VPX20, and XC2VP30**

Bank	Pin Description		Pin Number	No Connects		
	Virtex-II Pro devices	XC2VPX20 (if Different)		XC2VP7	XC2VP20, XC2VPX20	XC2VP30
N/A	GND		C14			
N/A	GND		C3			
N/A	GND		B29			
N/A	GND		B2			
N/A	GND		A22			
N/A	GND		A9			

Notes:
1. See Table 4 for an explanation of the signals available on this pin.

Table 11: **FF1148 — XC2VP40 and XC2VP50**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
2	IO_L02P_2	D9		
2	IO_L03N_2	B7		
2	IO_L03P_2	A7		
2	IO_L04N_2/VREF_2	B6		
2	IO_L04P_2	A6		
2	IO_L05N_2	E8		
2	IO_L05P_2	D8		
2	IO_L06N_2	B4		
2	IO_L06P_2	A4		
2	IO_L07N_2	B3		
2	IO_L07P_2	A3		
2	IO_L08N_2	H7		
2	IO_L08P_2	H8		
2	IO_L09N_2	C6		
2	IO_L09P_2	C7		
2	IO_L10N_2/VREF_2	C5		
2	IO_L10P_2	B5		
2	IO_L11N_2	K8		
2	IO_L11P_2	J8		
2	IO_L12N_2	C1		
2	IO_L12P_2	C2		
2	IO_L13N_2	E7		
2	IO_L13P_2	D7		
2	IO_L14N_2	J6		
2	IO_L14P_2	J7		
2	IO_L15N_2	D5		
2	IO_L15P_2	D6		
2	IO_L16N_2/VREF_2	E4		
2	IO_L16P_2	D4		
2	IO_L17N_2	L9		
2	IO_L17P_2	K9		
2	IO_L18N_2	E3		
2	IO_L18P_2	D3		
2	IO_L19N_2	D1		
2	IO_L19P_2	D2		
2	IO_L20N_2	K7		
2	IO_L20P_2	L7		
2	IO_L21N_2	F6		

Table 11: **FF1148 — XC2VP40 and XC2VP50**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
N/A	GND	AP5		
N/A	GND	AK5		
N/A	GND	AF5		
N/A	GND	AB5		
N/A	GND	W5		
N/A	GND	T5		
N/A	GND	N5		
N/A	GND	J5		
N/A	GND	E5		
N/A	GND	A5		
N/A	GND	AM3		
N/A	GND	C3		
N/A	GND	AN2		
N/A	GND	B2		
N/A	GND	AK1		
N/A	GND	AF1		
N/A	GND	AB1		
N/A	GND	W1		
N/A	GND	V1		
N/A	GND	T1		
N/A	GND	N1		
N/A	GND	J1		
N/A	GND	E1		

Notes:
1. See Table 4 for an explanation of the signals available on this pin.

Table 12: **FF1517 — XC2VP50 and XC2VP70**

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
2	VCCO_2	F8		
2	VCCO_2	U7		
2	VCCO_2	Y5		
2	VCCO_2	N4		
2	VCCO_2	J4		
2	VCCO_2	E4		
2	VCCO_2	U3		
2	VCCO_2	E1		
1	VCCO_1	N14		
1	VCCO_1	K13		
1	VCCO_1	F13		
1	VCCO_1	P19		
1	VCCO_1	P18		
1	VCCO_1	P17		
1	VCCO_1	K17		
1	VCCO_1	F17		
1	VCCO_1	P16		
1	VCCO_1	N16		
1	VCCO_1	P15		
1	VCCO_1	N15		
0	VCCO_0	K27		
0	VCCO_0	F27		
0	VCCO_0	N26		
0	VCCO_0	P25		
0	VCCO_0	N25		
0	VCCO_0	P24		
0	VCCO_0	N24		
0	VCCO_0	P23		
0	VCCO_0	K23		
0	VCCO_0	F23		
0	VCCO_0	P22		
0	VCCO_0	P21		
N/A	CCLK	AJ10		
N/A	PROG_B	D32		
N/A	DONE	AJ11		
N/A	M0	AP31		
N/A	M1	AJ30		

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
5	IO_L64N_5		AU24		
5	IO_L64P_5		AV24		
5	IO_L60N_5		AR24		
5	IO_L60P_5		AT24		
5	IO_L59N_5		AN24		
5	IO_L59P_5		AP24		
5	IO_L58N_5		AL24		
5	IO_L58P_5		AM24		
5	IO_L57N_5/VREF_5		AY26		
5	IO_L57P_5		AY25		
5	IO_L56N_5		AV25		
5	IO_L56P_5		AV26		
5	IO_L55N_5		AR25		
5	IO_L55P_5		AT25		
5	IO_L54N_5		AM25		
5	IO_L54P_5		AN25		
5	IO_L53_5/No_Pair		AW26		
5	IO_L50_5/No_Pair		AW27		
5	IO_L49N_5		AT26		
5	IO_L49P_5		AU26		
5	IO_L48N_5		AP26		
5	IO_L48P_5		AR26		
5	IO_L47N_5		AN26		
5	IO_L47P_5		AM26		
5	IO_L46N_5		AL26		
5	IO_L46P_5		AL25		
5	IO_L45N_5/VREF_5		AU27		
5	IO_L45P_5		AV27		
5	IO_L44N_5		AT27		
5	IO_L44P_5		AR27		
5	IO_L43N_5		AN27		
5	IO_L43P_5		AP27		
5	IO_L39N_5		AL27		
5	IO_L39P_5		AM27		
5	IO_L38N_5		AY28		
5	IO_L38P_5		AY29		

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
7	IO_L27P_7		P33		
7	IO_L27N_7		P34		
7	IO_L26P_7		N31		
7	IO_L26N_7		N32		
7	IO_L25P_7		N41		
7	IO_L25N_7		N42		
7	IO_L24P_7		N39		
7	IO_L24N_7		N40		
7	IO_L23P_7		N33		
7	IO_L23N_7		N34		
7	IO_L22P_7		N37		
7	IO_L22N_7/VREF_7		N38		
7	IO_L21P_7		N35		
7	IO_L21N_7		N36		
7	IO_L20P_7		M38		
7	IO_L20N_7		M39		
7	IO_L19P_7		M40		
7	IO_L19N_7		M41		
7	IO_L18P_7		M33		
7	IO_L18N_7		M34		
7	IO_L17P_7		M31		
7	IO_L17N_7		M32		
7	IO_L16P_7		M35		
7	IO_L16N_7/VREF_7		M36		
7	IO_L15P_7		L41		
7	IO_L15N_7		L42		
7	IO_L14P_7		L39		
7	IO_L14N_7		L38		
7	IO_L13P_7		L40		
7	IO_L13N_7		K40		
7	IO_L12P_7		L36		
7	IO_L12N_7		L37		
7	IO_L11P_7		L34		
7	IO_L11N_7		L35		
7	IO_L10P_7		K42		
7	IO_L10N_7/VREF_7		K41		

Table 13: **FF1704 — XC2VP70, XC2VPX70, and XC2VP100**

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
N/A	TXPPAD7		A20		
N/A	GNDA7		C21		
N/A	RXPPAD7		A19		
N/A	RXNPAD7		A18		
N/A	VTRXPAD7		B19		
N/A	AVCCAUXRX7		B18		
N/A	AVCCAUXTX8		B16		
N/A	VTTXPAD8		B17		
N/A	TXNPAD8		A17		
N/A	TXPPAD8		A16		
N/A	GNDA8		C16		
N/A	RXPPAD8		A15		
N/A	RXNPAD8		A14		
N/A	VTRXPAD8		B15		
N/A	AVCCAUXRX8		B14		
N/A	AVCCAUXTX9		B12		
N/A	VTTXPAD9		B13		
N/A	TXNPAD9		A13		
N/A	TXPPAD9		A12		
N/A	GNDA9		C12		
N/A	RXPPAD9		A11		
N/A	RXNPAD9		A10		
N/A	VTRXPAD9		B11		
N/A	AVCCAUXRX9		B10		
N/A	AVCCAUXTX10		B8		
N/A	VTTXPAD10		B9		
N/A	TXNPAD10		A9		
N/A	TXPPAD10		A8		
N/A	GNDA10		C8		
N/A	RXPPAD10		A7		
N/A	RXNPAD10		A6		
N/A	VTRXPAD10		B7		
N/A	AVCCAUXRX10		B6		
N/A	AVCCAUXTX11		B4		
N/A	VTTXPAD11		B5		
N/A	TXNPAD11		A5		

Table 14: **FF1696 — XC2VP100**

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
3	IO_L67P_3	AU5	
3	IO_L66N_3	AU1	
3	IO_L66P_3	AU2	
3	IO_L65N_3	AJ9	
3	IO_L65P_3	AK8	
3	IO_L64N_3	AU8	
3	IO_L64P_3	AV8	
3	IO_L63N_3/VREF_3	AU7	
3	IO_L63P_3	AV7	
3	IO_L62N_3	AL8	
3	IO_L62P_3	AL9	
3	IO_L61N_3	AU3	
3	IO_L61P_3	AV2	
3	IO_L84N_3	AV6	
3	IO_L84P_3	AW5	
3	IO_L83N_3	AM8	
3	IO_L83P_3	AM9	
3	IO_L82N_3	AV4	
3	IO_L82P_3	AW4	
3	IO_L81N_3/VREF_3	AV3	
3	IO_L81P_3	AW3	
3	IO_L80N_3	AN9	
3	IO_L80P_3	AP8	
3	IO_L79N_3	AW1	
3	IO_L79P_3	AW2	
3	IO_L78N_3	AY7	
3	IO_L78P_3	AY8	
3	IO_L77N_3	AR8	
3	IO_L77P_3	AR9	
3	IO_L76N_3	AW7	
3	IO_L76P_3	AY6	
3	IO_L75N_3/VREF_3	AY3	
3	IO_L75P_3	AY4	
3	IO_L74N_3	AT9	
3	IO_L74P_3	AU9	
3	IO_L73N_3	AY5	
3	IO_L73P_3	BA5	

Table 14: **FF1696 — XC2VP100**

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
4	IO_L26P_4	AU12	
4	IO_L27N_4	AR12	
4	IO_L27P_4/VREF_4	AP12	
4	IO_L28N_4	AW13	
4	IO_L28P_4	AW12	
4	IO_L29N_4	BA12	
4	IO_L29P_4	AY12	
4	IO_L30N_4	AN13	
4	IO_L30P_4	AM13	
4	IO_L34N_4	AU13	
4	IO_L34P_4	AT13	
4	IO_L35N_4	BA13	
4	IO_L35P_4	AY13	
4	IO_L36N_4	AM14	
4	IO_L36P_4/VREF_4	AL14	
4	IO_L76N_4	AR15	
4	IO_L76P_4	AT14	
4	IO_L77N_4	AV14	
4	IO_L77P_4	AU14	
4	IO_L78N_4	AP14	
4	IO_L78P_4	AN14	
4	IO_L79N_4	AW15	
4	IO_L79P_4	AY14	
4	IO_L80_4/No_Pair	BB14	
4	IO_L83_4/No_Pair	BA14	
4	IO_L84N_4	AM15	
4	IO_L84P_4	AL15	
4	IO_L85N_4	AT16	
4	IO_L85P_4	AT15	
4	IO_L86N_4	AV15	
4	IO_L86P_4	AU15	
4	IO_L87N_4	AP15	
4	IO_L87P_4/VREF_4	AN15	
4	IO_L37N_4	AY16	
4	IO_L37P_4	AY15	
4	IO_L38N_4	BB15	
4	IO_L38P_4	BA15	

Table 14: **FF1696 — XC2VP100**

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
6	IO_L02P_6	BA34	
6	IO_L02N_6	AY34	
6	IO_L03P_6	BB37	
6	IO_L03N_6/VREF_6	BA37	
6	IO_L04P_6	BB36	
6	IO_L04N_6	BA36	
6	IO_L05P_6	AW34	
6	IO_L05N_6	AW35	
6	IO_L06P_6	BB35	
6	IO_L06N_6	BA35	
6	IO_L73P_6	BA38	
6	IO_L73N_6	AY38	
6	IO_L74P_6	AU34	
6	IO_L74N_6	AT34	
6	IO_L75P_6	AY39	
6	IO_L75N_6/VREF_6	AY40	
6	IO_L76P_6	AY37	
6	IO_L76N_6	AW36	
6	IO_L77P_6	AR34	
6	IO_L77N_6	AR35	
6	IO_L78P_6	AY35	
6	IO_L78N_6	AY36	
6	IO_L79P_6	AW41	
6	IO_L79N_6	AW42	
6	IO_L80P_6	AP35	
6	IO_L80N_6	AN34	
6	IO_L81P_6	AW40	
6	IO_L81N_6/VREF_6	AV40	
6	IO_L82P_6	AW39	
6	IO_L82N_6	AV39	
6	IO_L83P_6	AM34	
6	IO_L83N_6	AM35	
6	IO_L84P_6	AW38	
6	IO_L84N_6	AV37	
6	IO_L61P_6	AV41	
6	IO_L61N_6	AU40	
6	IO_L62P_6	AL34	

Table 14: **FF1696 — XC2VP100**

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
7	IO_L45N_7	T36	
7	IO_L44P_7	W32	
7	IO_L44N_7	W33	
7	IO_L43P_7	R41	
7	IO_L43N_7	R42	
7	IO_L42P_7	P40	
7	IO_L42N_7	R40	
7	IO_L41P_7	V36	
7	IO_L41N_7	V37	
7	IO_L40P_7	R38	
7	IO_L40N_7/VREF_7	R39	
7	IO_L39P_7	P38	
7	IO_L39N_7	R37	
7	IO_L38P_7	V34	
7	IO_L38N_7	V35	
7	IO_L37P_7	P41	
7	IO_L37N_7	P42	
7	IO_L36P_7	P36	
7	IO_L36N_7	P37	
7	IO_L35P_7	V32	
7	IO_L35N_7	V33	
7	IO_L34P_7	M41	
7	IO_L34N_7/VREF_7	N41	
7	IO_L33P_7	N39	
7	IO_L33N_7	N40	
7	IO_L32P_7	U35	
7	IO_L32N_7	U36	
7	IO_L31P_7	N36	
7	IO_L31N_7	N37	
7	IO_L30P_7	M39	
7	IO_L30N_7	M40	
7	IO_L29P_7	U32	
7	IO_L29N_7	U33	
7	IO_L28P_7	M37	
7	IO_L28N_7/VREF_7	M38	
7	IO_L27P_7	L37	
7	IO_L27N_7	M36	

Table 14: **FF1696 — XC2VP100**

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
2	VCCO_2	F4	
1	VCCO_1	R21	
1	VCCO_1	P21	
1	VCCO_1	R20	
1	VCCO_1	P20	
1	VCCO_1	R19	
1	VCCO_1	P19	
1	VCCO_1	R18	
1	VCCO_1	P18	
1	VCCO_1	H18	
1	VCCO_1	D18	
1	VCCO_1	P17	
1	VCCO_1	H14	
1	VCCO_1	D14	
1	VCCO_1	M13	
1	VCCO_1	D10	
0	VCCO_0	D33	
0	VCCO_0	M30	
0	VCCO_0	H29	
0	VCCO_0	D29	
0	VCCO_0	P26	
0	VCCO_0	R25	
0	VCCO_0	P25	
0	VCCO_0	H25	
0	VCCO_0	D25	
0	VCCO_0	R24	
0	VCCO_0	P24	
0	VCCO_0	R23	
0	VCCO_0	P23	
0	VCCO_0	R22	
0	VCCO_0	P22	
N/A	CCLK	AM10	
N/A	PROG_B	J33	
N/A	DONE	AN10	
N/A	M0	AP33	
N/A	M1	AN33	